



Inline Vacuum Reflow Soldering Systems since 2009



SMT Highlights:

- Tool-free maintenance of all SMT Systems
- **NEW!** CATalysis process gas cleaning
- Sustainable energy and nitrogen saving concept
- Prooven Vacuum Reflow Technology (since 2009)
- **NEW!** Independent fan control in all zones

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Inline Vakuum Reflow Soldering System since 2009



Void-free soldering is a basic requirement in the highperformance electronics. Life-sustaining devices, control systems on the plane and driving assistance systems in the automotive sector all have one thing in common: They have to function completely safe and faultlessly over an extended period of time. Base requirement for accomplishing this is a high-strength almost **void-free solder joint**. Voids in a solder joint have to be reduced to an acceptable minimum.

SMT offers with its vacuum reflow soldering system a unique solution on the market. The vacuum process starts after the melting process in the peak area. The assembly is driven with the molten solder through an **in-line transport system** in the vacuum chamber. By using vacuum the voids of the solder joint are drawn. Subsequently, the assembly is moved to the cooling zone where the solder solidifies.



In vacuum reflow soldering systems all proven and field-tested systems properties were adopted from our reflow soldering systems, which are especially characterized by **long life time** and **high process reliability**.



2009, the first SMT Vacuum Reflow Soldering System was introduced. Already in the following year SMT has received numerous awards for its vacuum reflow soldering technology.



Subject to change without notice, 10/08/2016



Reflow-Highlights

- CATalysis: Cleaning process can take place due to the catalyst at lower temperatures
 - → better cleaning performance
 - **Granulate with precious metal coating** provide a splitting of long-chain hydro-carbons and the organic material is ideally split completely to water and carbon dioxide
- Precise nitrogen control by integrated lambda sensor technology and real-time continuous measurements of residual oxygen value
 less nitrogen consumption
 - → easy calibration (exchange possible by customer)
- Gas-tight fan units
 - Constant process gas, adjustable via frequency converter
 - Encapsulated, maintenance-free fan motor, no slight leakiness
 - → Energy and nitrogen savings
- Lowest operating costs
 - Lowest energy and media consumption
 - Lowest consumption of spare and wear parts
 - (e.g. rails, chain, fan motors, heating elements)





- Vacuum module between peak and cooling zone
- Stainless steal Vacuum chamber heatedly from the outside
 Inline System
- Nitrogen capable
- With and without vacuum process
- All parameter are individually adjustable

Soldering process with and without vacuum



Process parameter



Your Benefit

- Voids will be reduced up to 99%, solder joints quality optimized
- 2- and 3-lane conveyor possible
- Reliable transport transfer in the system
- Large vacuum pump (305 m³/h) → fast and reliable vacuum process
- Suitable for PCBs, DCB, stamping grid and carrier
- Parameter individually adjustable: Evacuation time; vacuum hold time; ventilation time; vacuum pressure

Sold Systems > 110 pcs. since end of 2009







VAC XL and VAC XL Plus on request.

Technical Data	VAC S	VAC M	VAC L	VAC L Plus
External dimensions				
Length incl. small VAC module (800 mm length):	5472 mm	5922 mm	7027 mm	7514 mm
Width:	1435 mm	1435 mm	1435 mm	1435 mm
Height (in delivery condition/with warning light) ^{1.)}	1767/2353 mm	1767/2353 mm	1767/2353 mm	1767/2353 mm
Inlet height, adjustable by customer: ^{1.)}	950 mm +/- 20 mm			
Weight	approx. 3100 kg	approx. 3300 kg	approx. 3700 kg	approx. 4600 kg
Number/rollers/diameter feet:	14/8/80 mm	15/8/80 mm	15/8/80 mm	16/8/80 mm
Process chamber				
Pre-heat-/peak zones/peak zones VAC module:	3/2/2	3/2/2	4/2/2	5/3/2
Active Convection length:	2861 mm	3311 mm	3943 mm	4430 mm
Cooling zones ^{2.)} :	dual = 1752 mm	dual = 1752 mm	triple = 2226 mm	triple = 2226 mm
Power				
Power consumption steady state condition system/VAC module: $^{3,)}$	approx. 10/7 kW h	approx. 10/7 kW h	approx. 11/7 kW h	approx. 12/7 kW h
1.) Standard height: 950 mm; corresponding to a changed inlet height				

2.) Up to 5 cooling zones possible. Each cooling zone: 474 mm

3.) Machine with chain conveyor, 220 mm transport width, fan speed reduction and no other options

Technical Data from VAC S up to VAC XL Plus

	Extraction ^{2.)}
222 512	
	Suction pipe:
450 x 510 mm	Required exhaust
	Temperature of ex
yes	Internal exhaust a
NiCr-Ni sensors in hot gas flow	Continuous soun
approx. 60 min.	Control unit
approx. 90 min.	Nitrogen Connec
100% forced convection	Connection armat
thermal radiation	Working pressure
max. 300 °C / 350 °C / 300 °C	N ₂ -consumption, s
	transport w
65 510 mm	N ₂ -consumption, f
Pin level -10 mm	transport w
left-right	Readiness for the sy
front	Connecting powe
30/30 mm	
3 kg/m	
0.2 3.0 m/min.	
2 x 1/2"	
> 15 ltr./min / > 2,5 bar	
< 15 °C	
	NiCr-Ni sensors in hot gas flow approx. 60 min. approx. 90 min. 100% forced convection thermal radiation max. 300 °C / 350 °C / 300 °C 65 510 mm Pin level -10 mm left-right front 30/30 mm 3 kg/m 0.2 3.0 m/min. 2 x 1/2" > 15 ltr./min / > 2,5 bar

 Differing at dual or triple lane
 Connection of a flexible, heat resisting (at least up to 100 °C) hose (available by SMT) or tube. The waste air exhausting unit with adjustable throttle valve mounted after the suction sleeves has to be installed by the user.

3.) N2-supply with pressure reducer has to be mounted by the user, recommended supply of nitrogen with oxygen content < 5 ppm. 4.) 1000 ppm with proportional valves and sleeping mode (options);

if 500 ppm then approx. 10 m³/h 5.) With PCB (220 x 220 mm), one PCB length distance, 1000 ppm;

if 500 ppm then approx. 17 m³/h

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SMD Reflow Vacuum Soldering Soldering

Coating + Curing







Suction pipe:	1 x Ø 200 mm, 1 x Ø 153 mm
Required exhaust air at pipe inlet/VAC:	approx. 600 800 m ³ /h
Temperature of exhaust air at the pipe:	< 50 °C
Internal exhaust air resistance of oven:	3 - 8 mbar
Continuous sound pressure level	< 70 dB(A)
Control unit	CDIAS with RT 7
Nitrogen Connection ^{3.)}	
Connection armature:	R 3/8" internal thread
Working pressure (at connecting armature):	6 8 bar
N ₂ -consumption, steady state condition at	
transport width 220 mm: 4.)	approx. 9 m ³ /h
N ₂ -consumption, full load at	
transport width 220 mm: ^{5.)}	approx. 15 m ³ /h
Readiness for the system (1000 ppm, $N_2 < 5$ ppm O_2):	approx. 15 min.
Connecting power supply:	3~N, PE 230 / 400 V, 50 Hz

The vacuum systems are individually configurable. Choose from a variety of lengths from heating zone length, vacuum module and the cooling zones and at transport system between a single, double or triple lane.

Ask us, we have the **perfect solution** for your application.